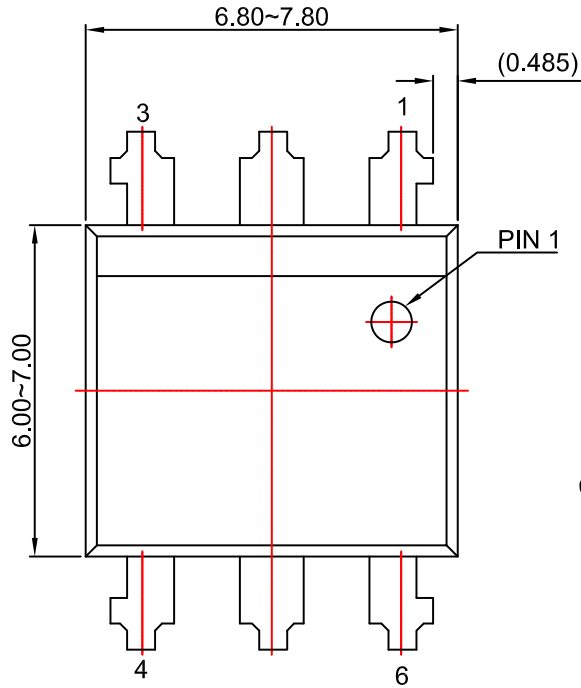


MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS



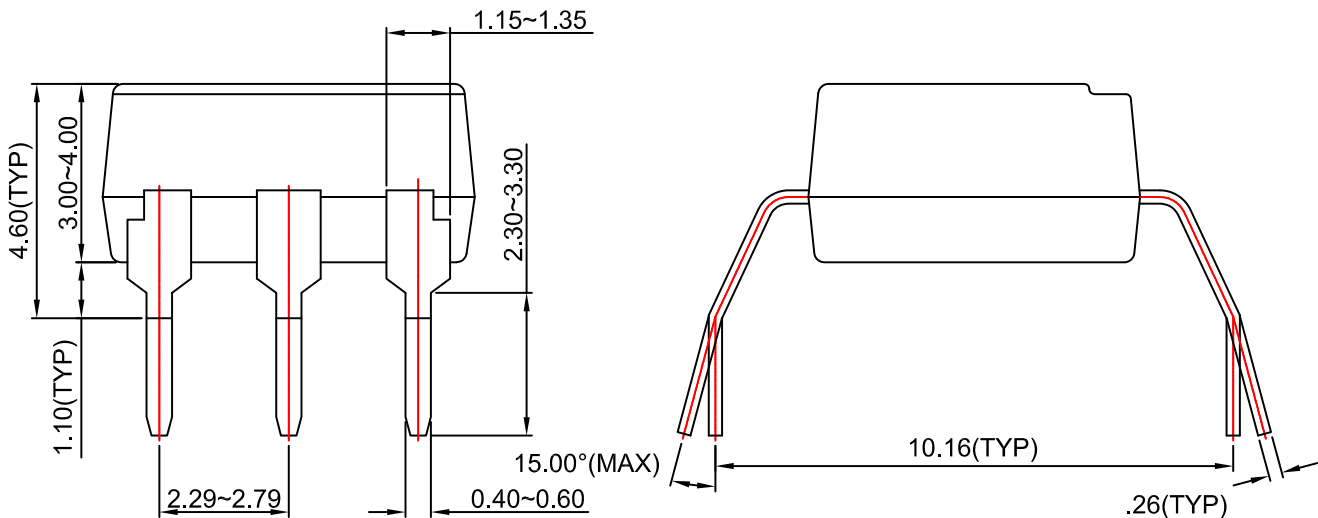
PDIP6 7.3x6.5, 2.54P
CASE 646CF
ISSUE O

DATE 31 JUL 2016



NOTES:

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION



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DESCRIPTION:	PDIP6 7.3X6.5, 2.54P	PAGE 1 OF 1

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